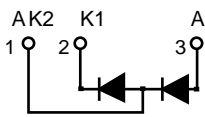


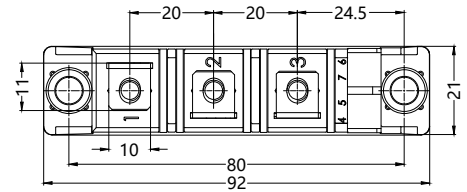
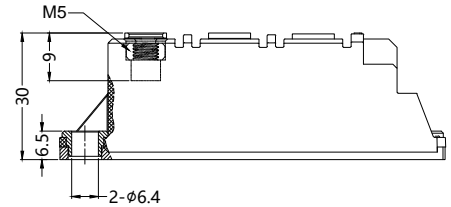
SDD60N18B

Diode-Diode Modules



Type	V_{RSM} V	V_{RRM} V
SDD60N08B	900	800
SDD60N12B	1300	1200
SDD60N14B	1500	1400
SDD60N16B	1700	1600
SDD60N18B	1900	1800

Holerance: $\pm 0.5\text{mm}$
Dimensions in mm (1mm=0.0394")



Symbol	Test Conditions	Maximum Ratings	Unit
I_{FRMS} I_{FAVM}	$T_{VJ}=T_{VJM}$ $T_C=100^\circ\text{C}$; 180° sine	100 60	A
I_{FSM}	$T_{VJ}=45^\circ\text{C}$ $V_R=0$ t=10ms (50Hz), sine t=8.3ms (60Hz), sine	1150 1300	A
	$T_{VJ}=T_{VJM}$ $V_R=0$ t=10ms(50Hz), sine t=8.3ms(60Hz), sine	1000 1200	
$\int i^2 dt$	$T_{VJ}=45^\circ\text{C}$ $V_R=0$ t=10ms (50Hz), sine t=8.3ms (60Hz), sine	6600 7000	A^2s
	$T_{VJ}=T_{VJM}$ $V_R=0$ t=10ms(50Hz), sine t=8.3ms(60Hz), sine	5000 5950	
T_{VJ} T_{VJM} T_{stg}		-40...+150 150 -40...+125	$^\circ\text{C}$
V_{ISOL}	50/60Hz, RMS $I_{ISOL} \leq 1\text{mA}$ t=1min t=1s	3000 3600	V~
M_d	Mounting torque (M5) Terminal connection torque (M5)	2.5-4/22-35 2.5-4/22-35	Nm/lb.in.
Weight	Typ.	105	g



Sirectifier®

SDD60N18B

Diode-Diode Modules

Symbol	Test Conditions	Characteristic Values	Unit
I_R	$T_{VJ}=T_{VJM}; V_R=V_{RRM}$	10	mA
V_F	$I_F=200A; T_{VJ}=25^{\circ}C$	1.50	V
V_{TO}	For power-loss calculations only	0.8	V
r_T	$T_{VJ}=T_{VJM}$	4.3	m Ω
Q_S	$T_{VJ}=125^{\circ}C; I_F=50A; -di/dt=0.64A/us$	90	μC
I_{RM}		11	A
R_{thJC}	per diode; DC current per module	0.40 0.20	K/W
R_{thJK}	per diode; DC current per module	0.60 0.30	K/W
d_s	Creepage distance on surface	12.7	mm
d_A	Strike distance through air	9.6	mm
a	Maximum allowable acceleration	50	m/s ²

FEATURES

- * International standard package
- * Copper base plate
- * Glass passivated chips
- * Isolation voltage 3600 V~
- * UL file NO.310749
- * RoHs compliant

APPLICATIONS

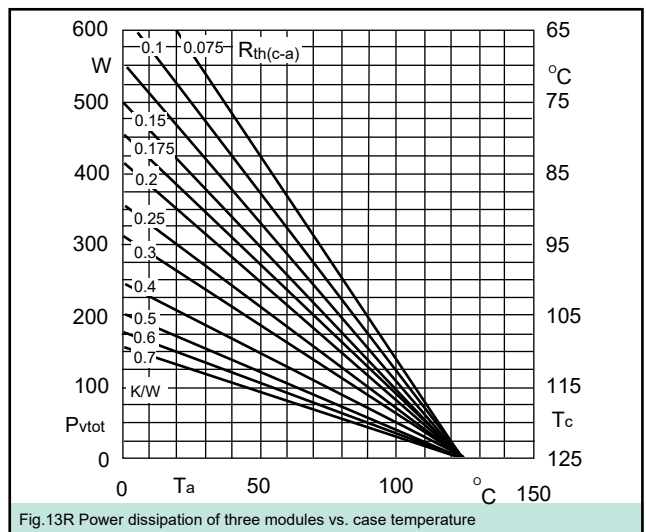
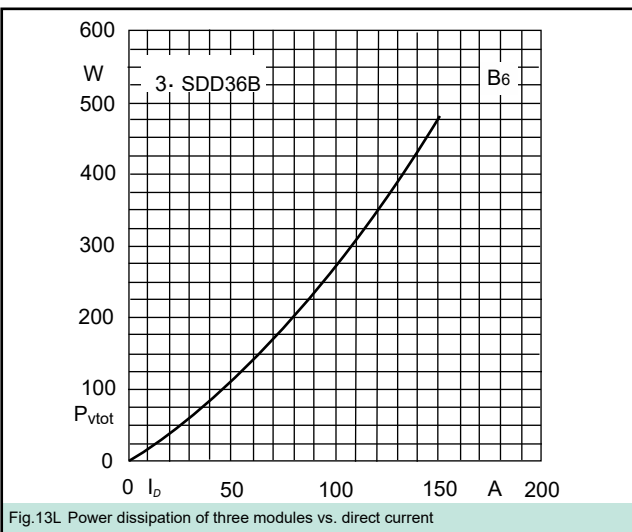
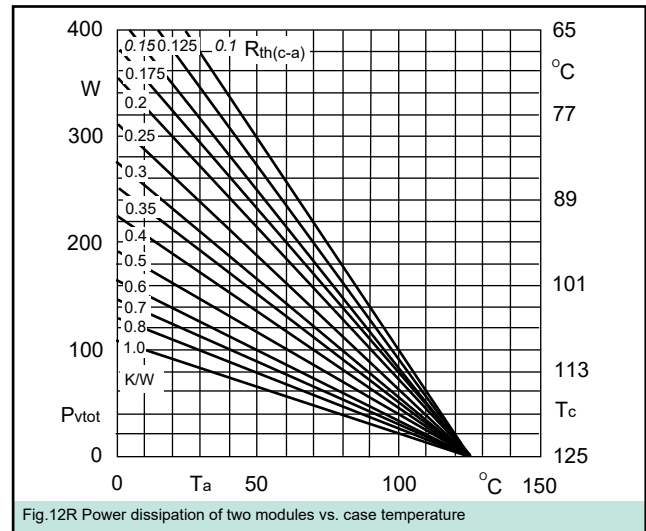
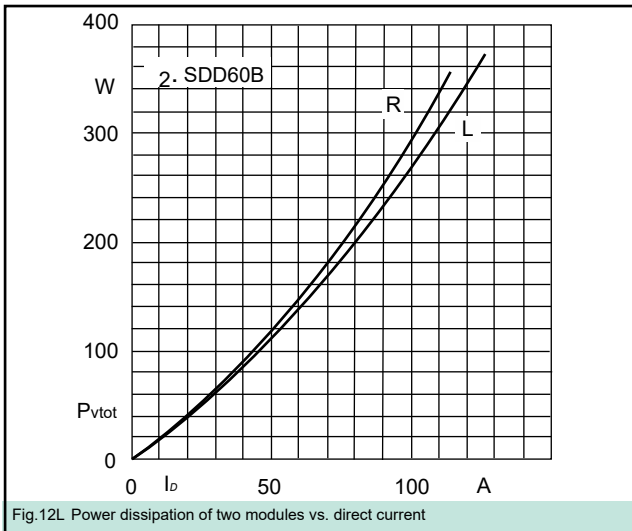
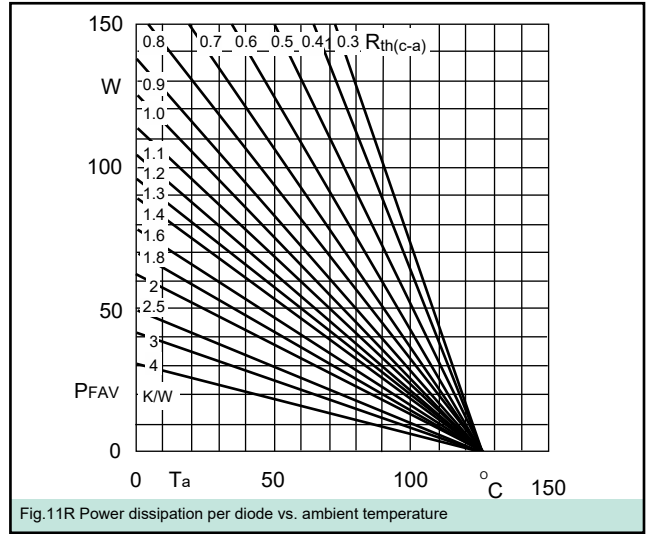
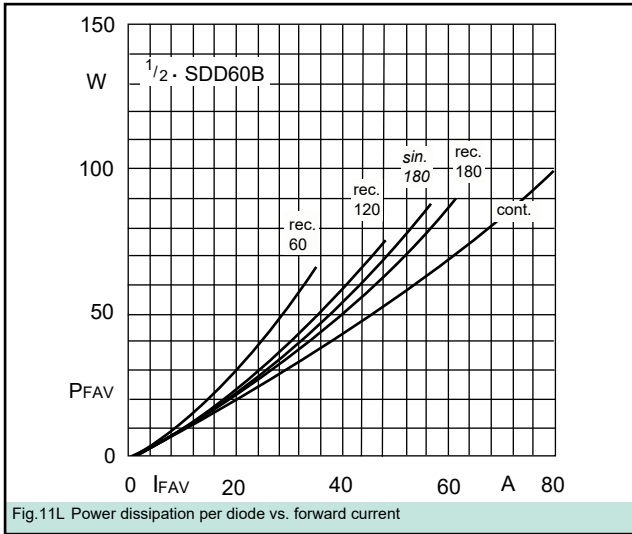
- * Supplies for DC power equipment
- * DC supply for PWM inverter
- * Field supply for DC motors
- * Battery DC power supplies

ADVANTAGES

- * Space and weight savings
- * Simple mounting
- * Improved temperature and power cycling
- * Reduced protection circuits

SDD60N18B

Diode-Diode Modules



SDD60N18B

Diode-Diode Modules

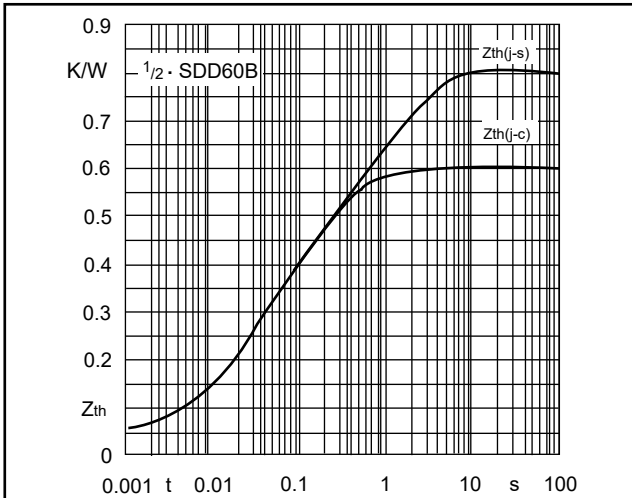


Fig. 14 Transient thermal impedance vs. time

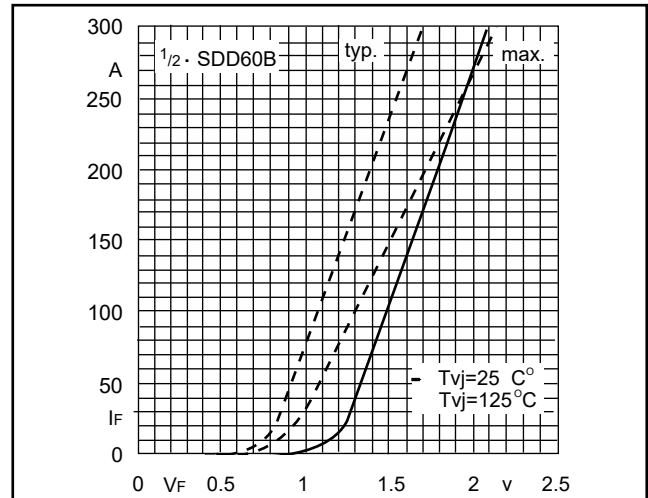


Fig. 15 Forward characteristics

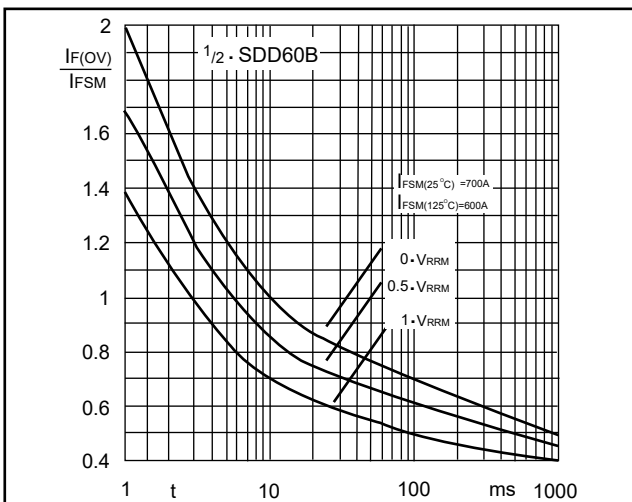


Fig. 16 Surge overload current vs. time